

SLAN-12D2A

Non-Isolated DC-DC Converter

The SLAN-12D2A modules are non-isolated DC-DC converters that can deliver up to 12 A of output current. These modules operate over a wide range of input voltage ($V_{IN} = 3 - 14.4$ VDC) and provide a precisely regulated output voltage from 0.6 to 5.5 VDC, programmable via an external resistor. Features include remote on/off, adjustable output voltage, over current and over temperature protection. The Tunable Loop™ feature allows the user to optimize the dynamic response of the converter to match the load with reduced amount of output capacitance leading to savings on cost and PWB area.



Key Features & Benefits

- Non-Isolated
- Power Good Signal
- Remote On/Off
- Over Temperature Protection
- Cost Efficient Open Frame Design
- DOSA Based
- Fixed Switching Frequency
- Class II, Category 2, Isolated DC/DC Converter (refer to IPC-9592B)
- Compliant to RoHS EU Directive 2002/95/EC
- Compatible in a Pb-free or SnPb Reflow Environment
- Output Voltage Programmable from 0.6 to 5.5 VDC via External Resistor
- Tunable Loop™ to Optimize Dynamic Output Voltage Response
- Output Over-Current Protection (non-latching)
- Wide Operating Temperature Range [-40°C to 85°C]
- Wide Input Voltage Range (3 - 14.4VDC)
- Approved to IEC/EN 60950-1
- Small size: 12.19 × 12.19 × 8.5 mm (0.48 × 0.48 × 0.335 inch)
- Cost Efficient Open Frame Design
- Ability to Sink and Source Current

Applications

- Distributed Power Architectures
- Servers and Storage Applications
- Intermediate Bus Voltage Applications
- Networking Equipment
- Telecommunications Equipment
- Industrial Equipment

1. MODEL SELECTION

MODEL NUMBER ACTIVE LOW	MODEL NUMBER ACTIVE HIGH	OUTPUT VOLTAGE	INPUT VOLTAGE	MAX. OUTPUT CURRENT	MAX. OUTPUT POWER	TYPICAL EFFICIENCY
SLAN-12D2ALR	SLAN-12D2A0R	0.6 – 5.5 VDC	3 – 14.4 VDC	12 A	66 W	95%
SLAN-12D2ALG	SLAN-12D2A0G					

PART NUMBER EXPLANATION

S	LAN	-	12	D	2A	x	x
Mounting type	Series code		Output current	Input voltage range	Sequencing or not	Logic status	Package
Surface mount	SLAN series		12 A	3 – 14.4 V	Without Sequencing	0 – Active High L – Active Low	G – Tray Package R – Tape & Reel Package

2. ABSOLUTE MAXIMUM RATINGS

PARAMETER	DESCRIPTION	MIN	TYP	UNITS
Continuous Input Voltage		-0.3	15	V
Operating Ambient Temperature	See Thermal Considerations section	-40	85	°C
Storage Temperature		-55	125	°C
Altitude		-	2000	m

NOTE: Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only, functional operation of the device is not implied at these or any other conditions in excess of those given in the operations sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect the device reliability.

3. INPUT SPECIFICATIONS

PARAMETER	DESCRIPTION	MIN	TYP	MAX	UNIT
Operating Input Voltage		3	-	14.4	V
Input Current (full load)	VIN = 3 to 14.4 V, Io = Io max	-	-	12	A
Input Current (no load)	Vo set = 0.6 VDC	-	45	-	mA
	Vo set = 5 VDC	-	75	-	
Input Stand-by Current	VIN = 12 V, module disabled	-	0.65	-	mA
Input Reflected Ripple Current (pk-pk)	5 Hz to 20 MHz, 1 μ H source impedance; VIN = 0 to 14 V, Io = Io max; See Test Configurations	-	40	-	mAp-p
I ² t Inrush Current Transient		-	-	1	A ² s
Input Ripple Rejection (120 Hz)		-	-60	-	dB

NOTE: Unless otherwise indicated, specifications apply over entire operating input voltage range, resistive load, and temperature conditions.

4. OUTPUT SPECIFICATIONS

PARAMETER	DESCRIPTION	MIN	TYP	MAX	UNIT
Output Voltage Set Point	With 0.1% tolerance for external resistor used to set output voltage	-1.0	-	+1.0	%Vo set
Output Voltage	Over entire operating input voltage range, resistive load, and temperature conditions until end of life	-3.0	-	+3.0	%Vo set
Adjustment Range	1. Selected by an external resistor 2. Some output voltages may not be possible depending on the input voltage – see Feature Descriptions Section	0.6	-	5.5	V
Remote Sense Range		-	-	0.5	V
Line Regulation	VO ≥ 2.5V	-	-	0.4	%Vo set
	VO < 2.5V	-	-	5	mV
Load Regulation	Io = Io min to Io max	-	-	10	mV
Temperature Regulation	Tref = Ta min to Ta max	-	-	0.4	%Vo set
Output Current	In either sink or source mode	0	-	12	A
Output Ripple and Noise (pk-pk)	5 Hz to 20 MHz BW, VIN = VIN nom and Io=Io min to Io max, Co = 0.1 µF // 22 µF ceramic capacitors	-	50	100	mV
Output Ripple and Noise (rms)		-	20	38	mV
Output Short-Circuit Current	Vo ≤ 250 mV, Hiccup Mode	-	1.5	-	A
Turn-On Delay Times (VIN=VIN nom, Io=Io max, Vo to within ±1% of steady state.)	Case 1: On/Off input is enabled and then input power is applied (delay from instant at which VIN = VIN min until Vo = 10% of Vo set)	-	5	-	ms
	Case 2: Input power is applied for at least one second and then the On/Off input is enabled (delay from instant at which Von/Off is enabled until Vo = 10% of Vo set)	-	5	-	ms
Output Voltage Overshoot	VIN = VIN min to Vin max, Io = Io min to Io max, TA = 25°C	-	-	3.0	%Vo set.
Output Voltage Rise Time	Time for Vo to rise from 10% of Vo set to 90% of Vo set	-	2	-	ms
Output Capacitance**	ESR ≥ 1 mΩ	22	-	47	µF
	ESR ≥ 0.15 mΩ	22	-	1000	
	ESR ≥ 10 mΩ	22	-	5000	
Output Current Limit Inception	1. Hiccup Mode 2. Current limit does not operate in sink mode	-	200	-	% Io max

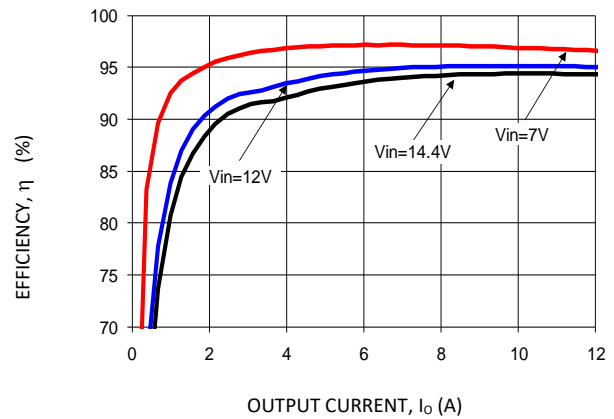
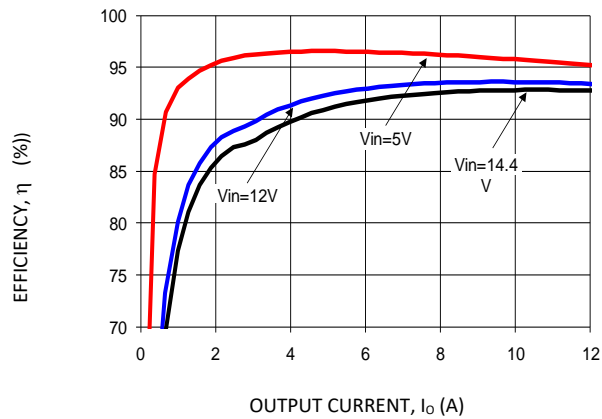
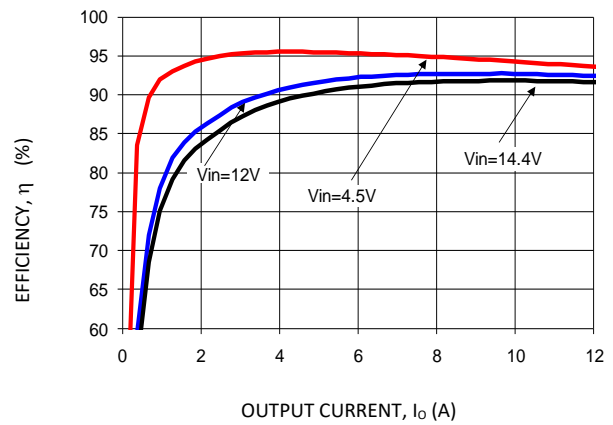
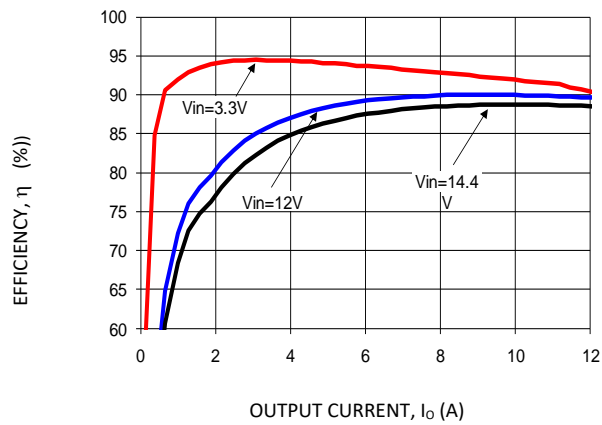
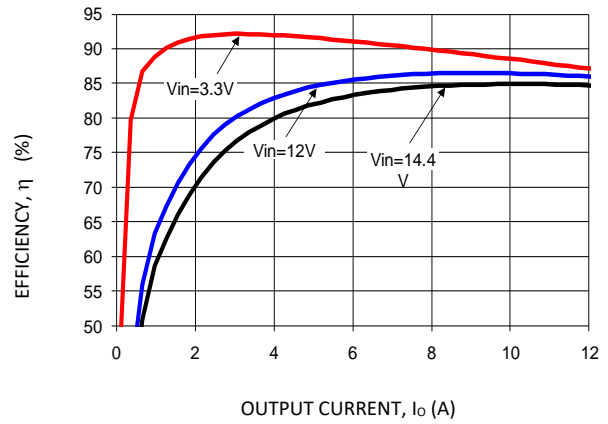
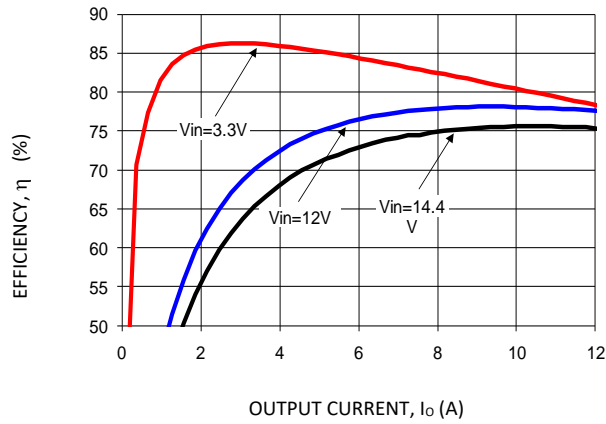
**** NOTE:** External capacitors may require using the new Tunable Loop™ feature to ensure that the module is stable as well as getting the best transient response. See the Tunable Loop™ section for details.

5. GENERAL SPECIFICATIONS

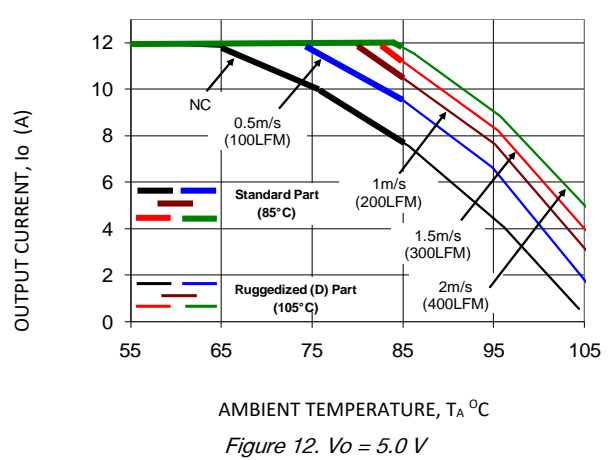
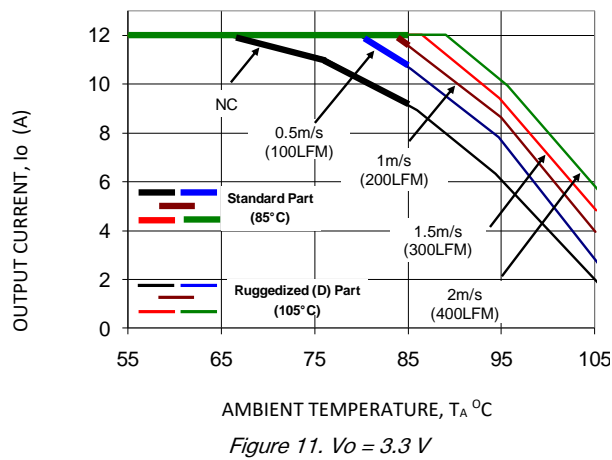
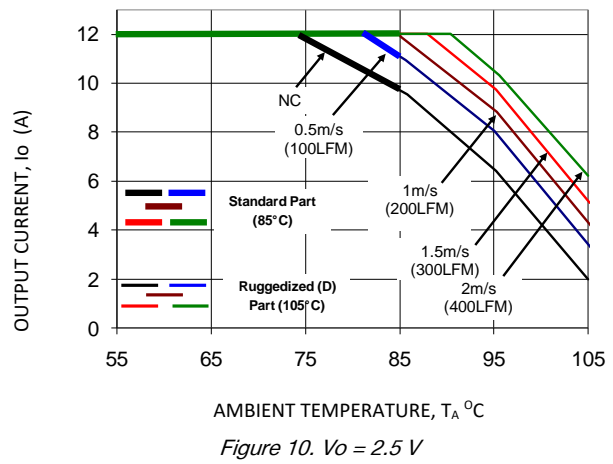
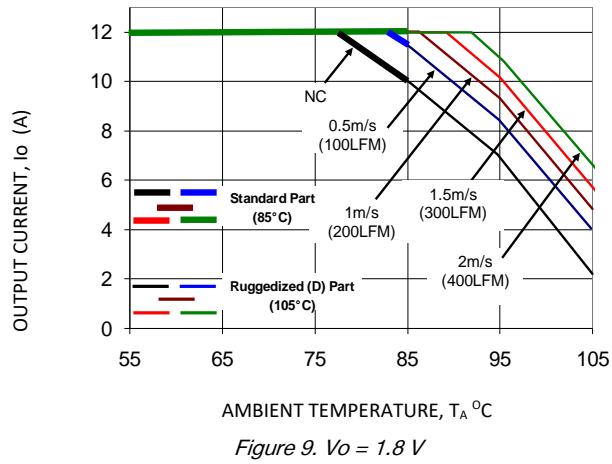
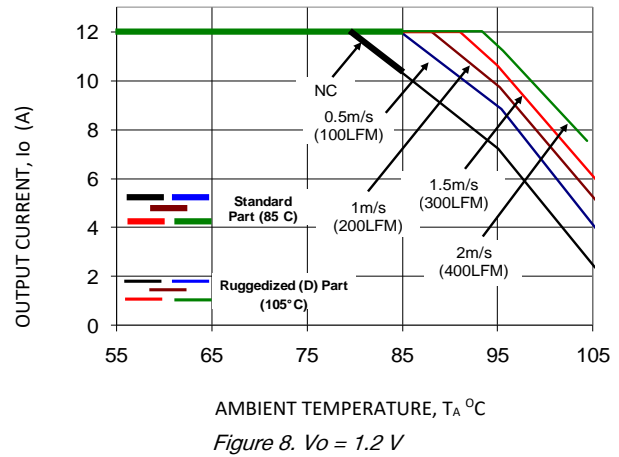
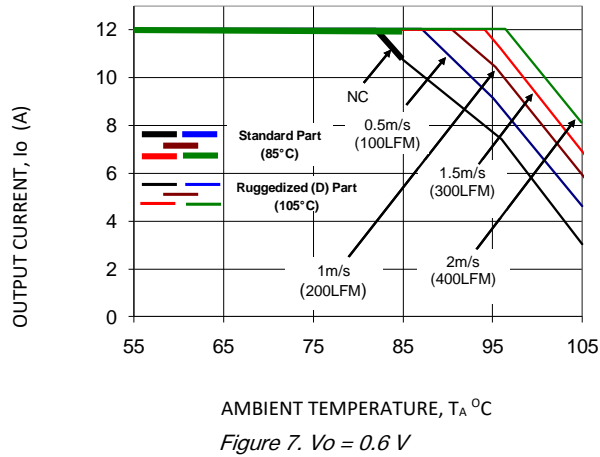
PARAMETER	DESCRIPTION	MIN	TYP	MAX	UNIT
Efficiency	Vo=0.6V	-	77.5	-	%
	Vo=1.2V	-	85.9	-	
	Vo=1.8V	-	89.6	-	
	Vo=2.5V	-	92.4	-	
	Vo=3.3V	-	93.4	-	
	Vo=5.0V	-	95.0	-	
Switching Frequency		-	600	-	kHz
Over Temperature Protection	See Thermal Considerations section	-	120/130	-	°C
PGOOD (Power Good)	Overvoltage threshold for PGOOD	-	112.5	-	%Vo set
	Undervoltage threshold for PGOOD	-	87.5	-	%Vo set
	Pulldown resistance of PGOOD pin	-	30	-	Ω
Weight		-	2.33	-	g
Input Undervoltage Lockout	Turn-on Threshold	-	-	2.9	V
	Turn-off Threshold	2.6	-	-	
	Hysteresis	-	0.3	-	
MTBF*	Calculated MTBF (Io = 0.8 Io max, TA = 40°C) Telecordia Issue 2 Method 1 Case 3		16,817,995		hours
Dimensions (L × W × H)			0.48 × 0.48 × 0.335		inch
			12.19 × 12.19 × 8.5		mm

NOTE: Unless otherwise indicated, specifications apply over entire operating input voltage range, resistive load, and temperature condition.

6. EFFICIENCY DATA



7. THERMAL DERATING CURVES



8. OUTPUT RIPPLE AND NOISE WAVEFORMS

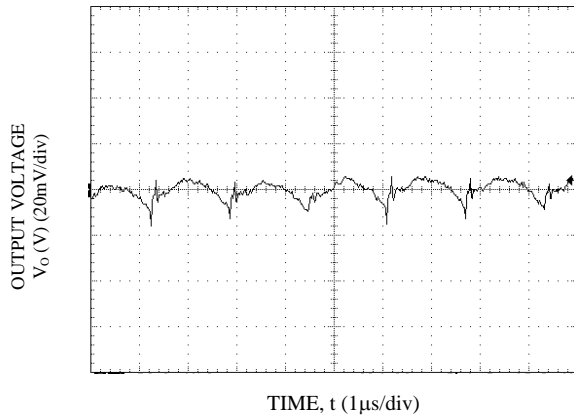


Figure 13. $V_o = 0.6\text{ V}$, $I_o = I_{o, \text{max}}$, $V_{in} = 8\text{ V}$

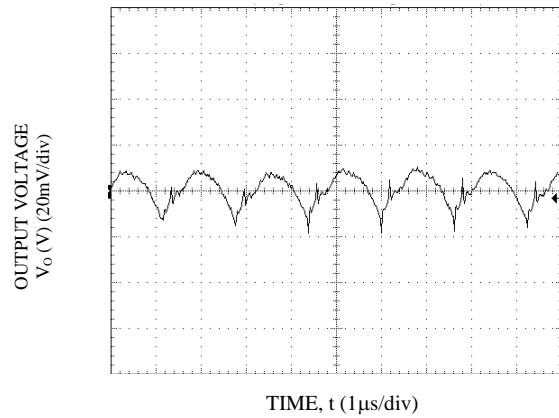


Figure 14. $V_o = 1.2\text{ V}$, $I_o = I_{o, \text{max}}$, $V_{in} = 12\text{ V}$

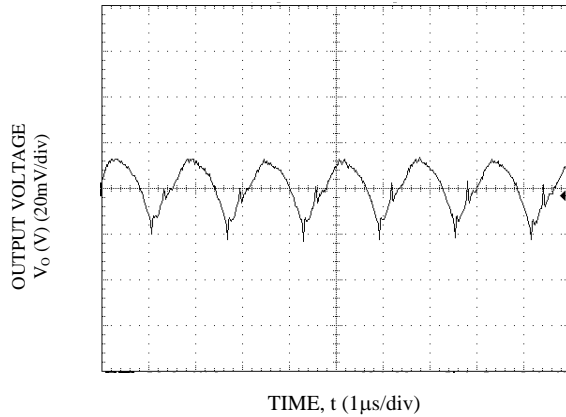


Figure 15. $V_o = 1.8\text{ V}$, $I_o = I_{o, \text{max}}$, $V_{in} = 12\text{ V}$

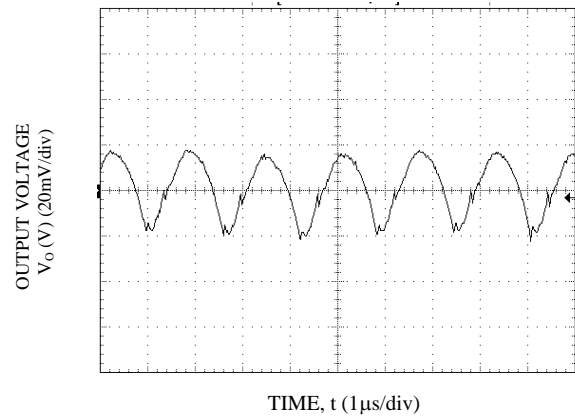


Figure 16. $V_o = 2.5\text{ V}$, $I_o = I_{o, \text{max}}$, $V_{in} = 12\text{ V}$

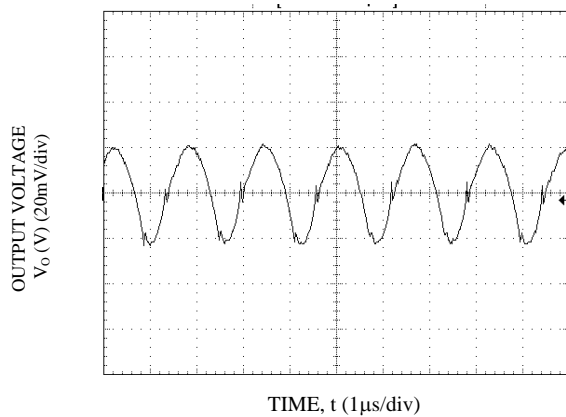


Figure 17. $V_o = 3.3\text{ V}$, $I_o = I_{o, \text{max}}$, $V_{in} = 12\text{ V}$

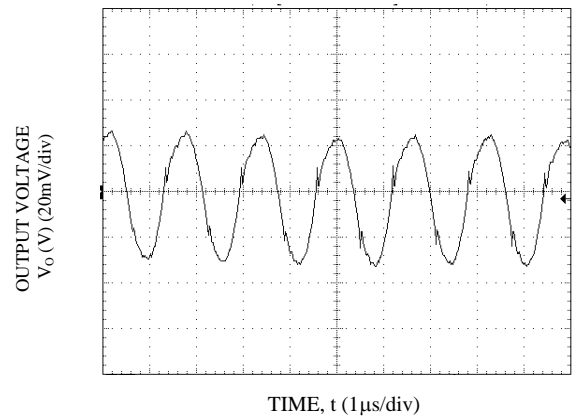


Figure 18. $V_o = 5.0\text{ V}$, $I_o = I_{o, \text{max}}$, $V_{in} = 12\text{ V}$

NOTE: $C_o = 22\text{ }\mu\text{F}$ ceramic.

9. STARTUP TIME

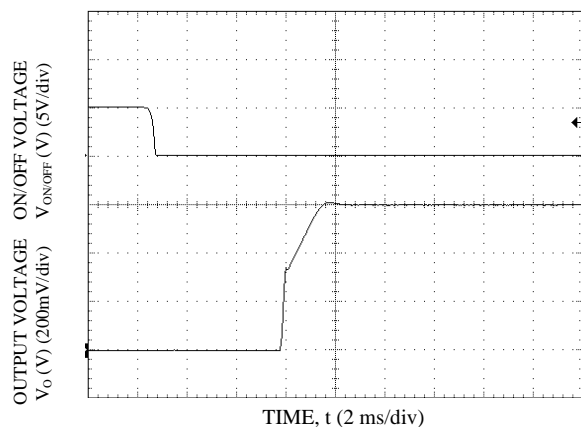


Figure 19. Start-up Using On/Off Voltage
($I_o = I_{o,max}$), $V_o = 0.6\text{ V}$

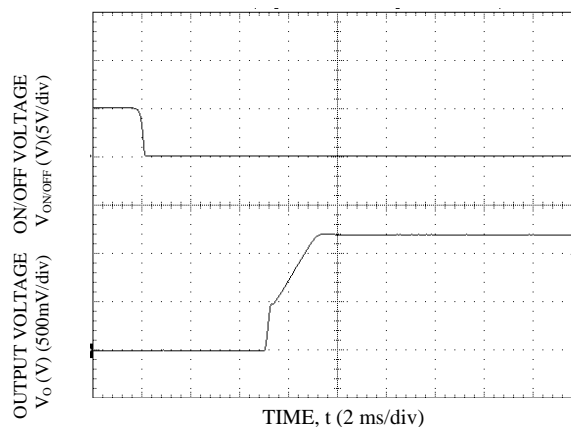


Figure 20. Start-up Using On/Off Voltage
($I_o = I_{o,max}$), $V_o = 1.2\text{ V}$

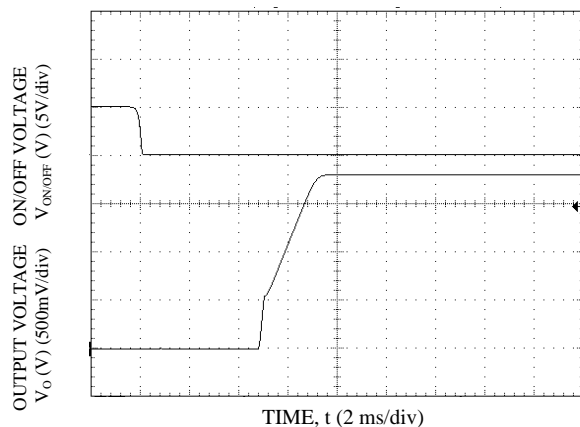


Figure 21. Start-up Using On/Off Voltage
($I_o = I_{o,max}$), $V_o = 1.8\text{ V}$

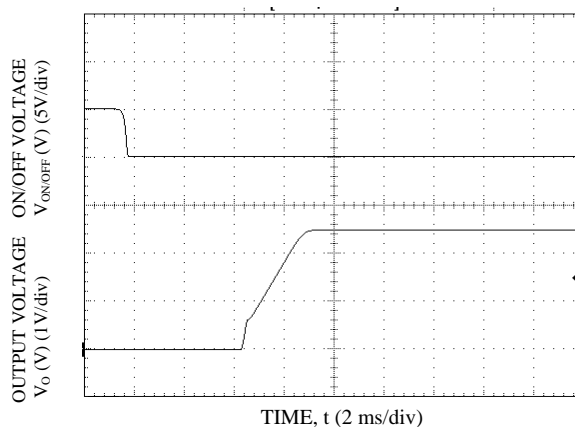


Figure 22. Start-up Using On/Off Voltage
($I_o = I_{o,max}$), $V_o = 2.5\text{ V}$

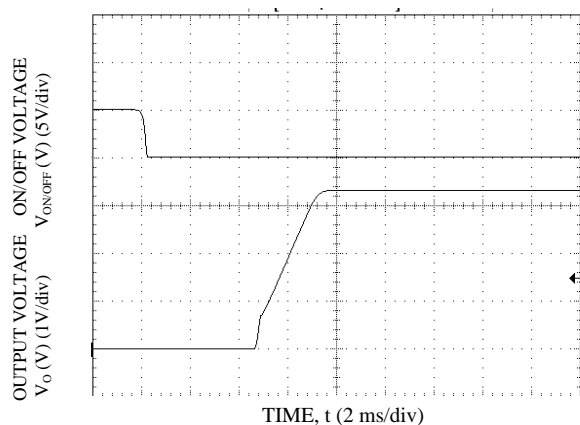


Figure 23. Start-up Using On/Off Voltage
($I_o = I_{o,max}$), $V_o = 3.3\text{ V}$

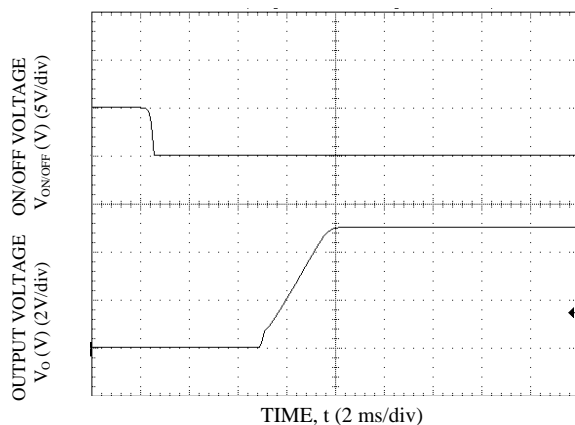


Figure 24. Start-up Using On/Off Voltage
($I_o = I_{o,max}$), $V_o = 5.0\text{ V}$

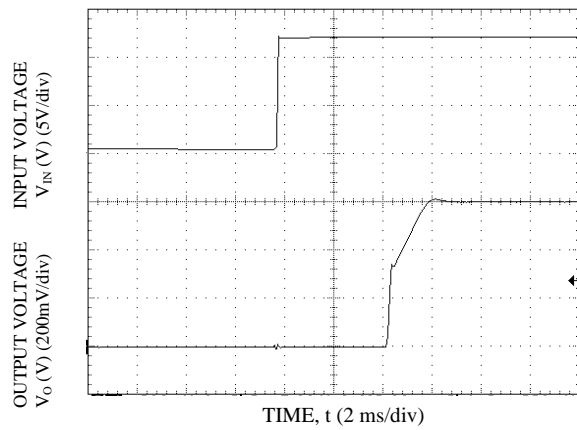


Figure 25. Start-up Using Input Voltage ($V_{IN} = 12V$, $I_o = I_{o,max}$), $V_O = 0.6V$

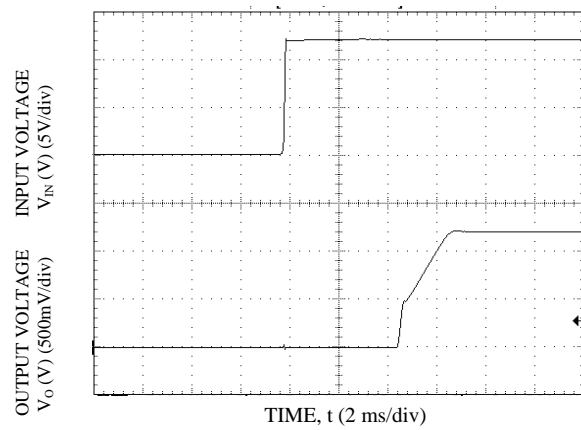


Figure 26. Start-up Using Input Voltage ($V_{IN} = 12V$, $I_o = I_{o,max}$), $V_O = 1.2V$

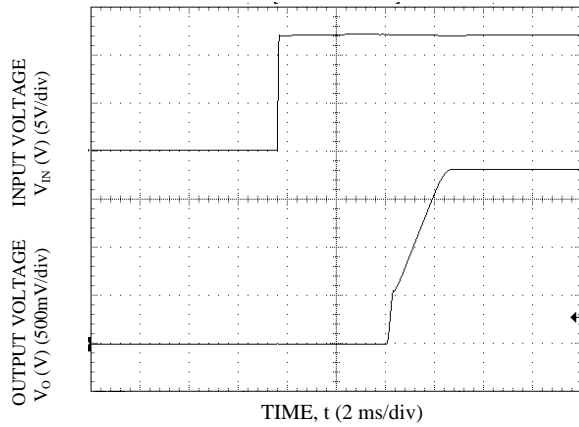


Figure 27. Start-up Using Input Voltage ($V_{IN} = 12V$, $I_o = I_{o,max}$), $V_O = 1.8V$

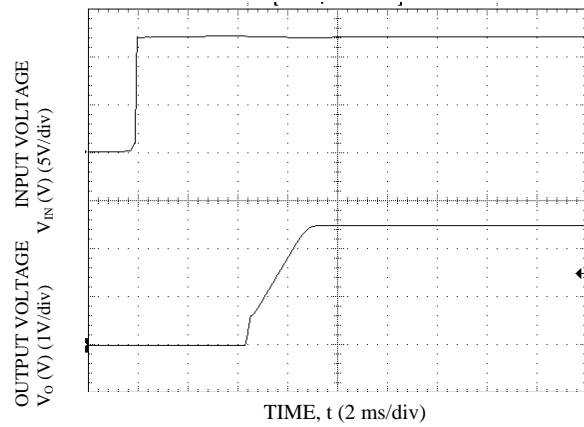


Figure 28. Start-up Using Input Voltage ($V_{IN} = 12V$, $I_o = I_{o,max}$), $V_O = 2.5V$

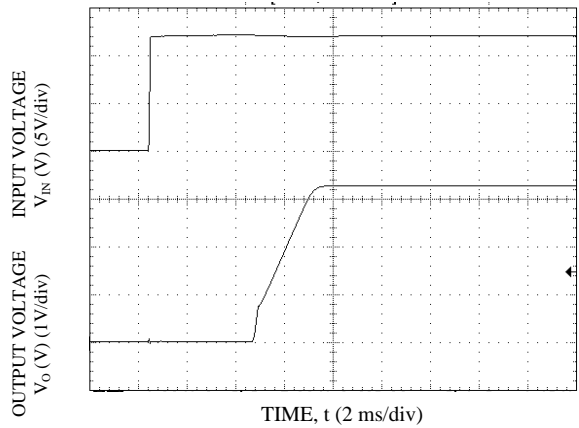


Figure 29. Start-up Using Input Voltage ($V_{IN} = 12V$, $I_o = I_{o,max}$), $V_O = 3.3V$

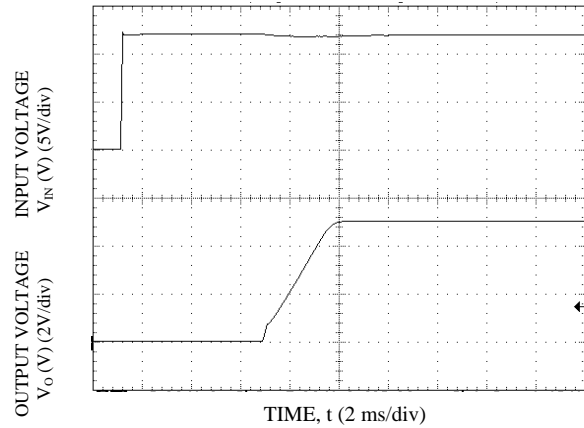


Figure 30. Start-up Using Input Voltage ($V_{IN} = 12V$, $I_o = I_{o,max}$), $V_O = 5.0V$

10. TRANSIENT RESPONSE WAVEFORMS

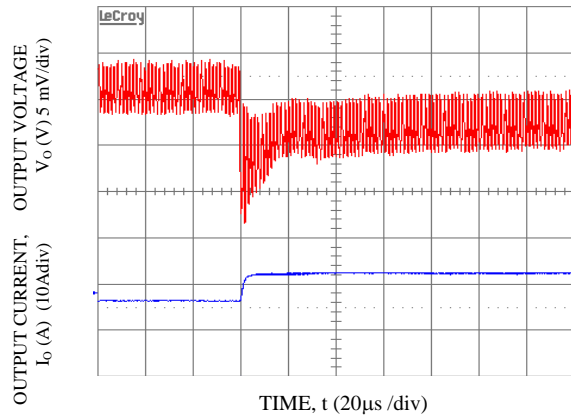


Figure 31. Transient Response to Dynamic Load Change from 50% to 100% at 12Vin, Cout-3x 47 μ F + 6x 330 μ F, CTune-47 nF, RTune-180 ohms. $V_o = 0.6$ V

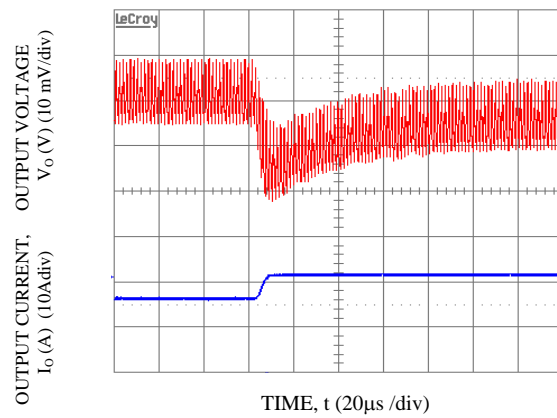


Figure 32. Transient Response to Dynamic Load Change from 50% to 100% at 12Vin, Cout-1x 47 μ F + 3x 330 μ F, CTune-10 nF & RTune-220 ohms. $V_o = 1.2$ V

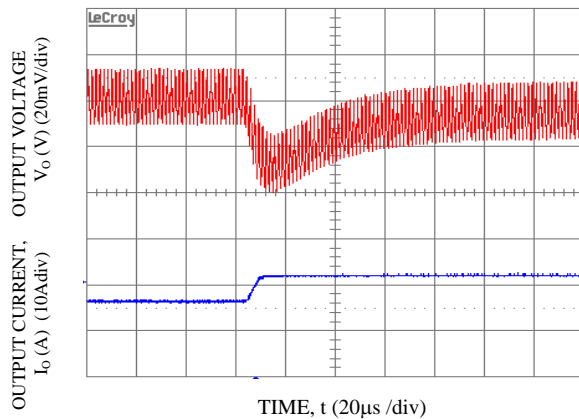


Figure 33. Transient Response to Dynamic Load Change from 50% to 100% at 12Vin, Cout-1x47 μ F+2x330 μ F, CTune-5600 pF & RTune-270 ohms. $V_o = 1.8$ V

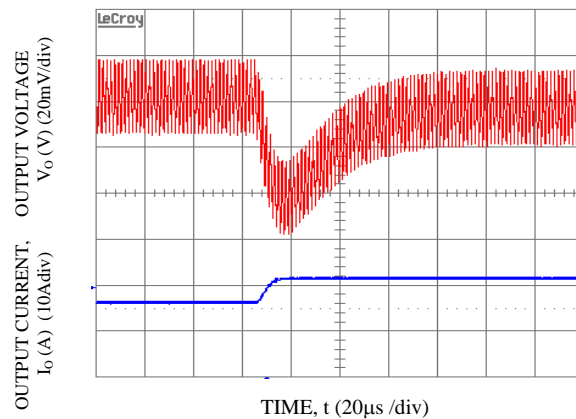


Figure 34. Transient Response to Dynamic Load Change from 50% to 100% at 12Vin, Cout-1x 47 μ F + 1x 330 μ F, CTune-3300pF & RTune-270 ohms. $V_o = 2.5$ V

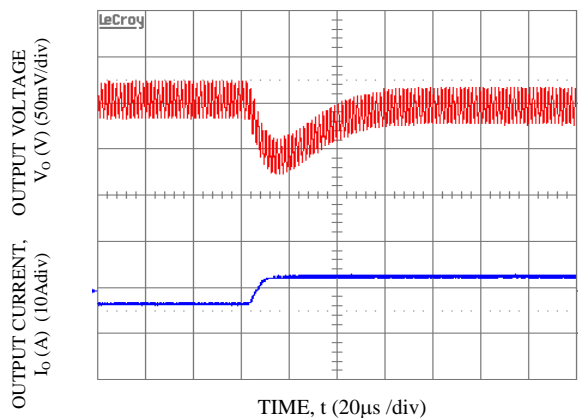


Figure 35. Transient Response to Dynamic Load Change from 50% to 100% at 12Vin, Cout-1x 47 μ F + 1x 330 μ F, CTune-2700 pF & RTune-330 ohms. $V_o = 3.3$ V

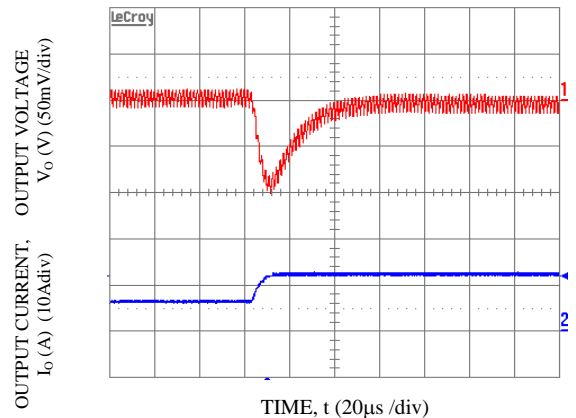


Figure 36. Transient Response to Dynamic Load Change from 50% to 100% at 12Vin, Cout-5x 47 μ F, CTune-1500 pF & RTune-330 ohms. $V_o = 5.0$ V

11. DESIGN CONSIDERATIONS

INPUT FILTERING

The SLAN-12D2Ax module should be connected to a low ac-impedance source. A highly inductive source can affect the stability of the module. An input capacitance must be placed directly adjacent to the input pin of the module, to minimize input ripple voltage and ensure module stability.

To minimize input voltage ripple, ceramic capacitors are recommended at the input of the module. Figure 37 shows the input ripple voltage for various output voltages at 12A of load current with 2x22 μ F or 3x22 μ F ceramic capacitors and an input of 12 V.

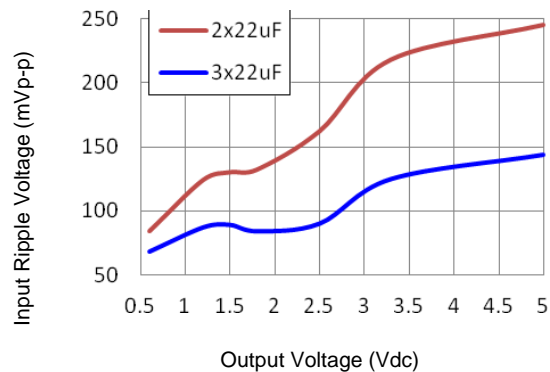


Figure 37.

NOTE: Input ripple voltage for various output voltages with 2x22 μ F or 3x22 μ F ceramic capacitors at the input (12 A load). Input voltage is 12 V.

OUTPUT FILTERING

The SLAN-12D2Ax modules are designed for low output ripple voltage and will meet the maximum output ripple specification with 0.1 μ F ceramic and 22 μ F ceramic capacitors at the output of the module. However, additional output filtering may be required by the system designer for a number of reasons. First, there may be a need to further reduce the output ripple and noise of the module. Second, the dynamic response characteristics may need to be customized to a particular load step change.

To reduce the output ripple and improve the dynamic response to a step load change, additional capacitance at the output can be used. Low ESR polymer and ceramic capacitors are recommended to improve the dynamic response of the module. Figure 38 provides output ripple information for different external capacitance values at various V_o and a full load current of 12A. For stable operation of the module, limit the capacitance to less than the maximum output capacitance as specified in the electrical specification table. Optimal performance of the module can be achieved by using the Tunable Loop™ feature described later in this data sheet.

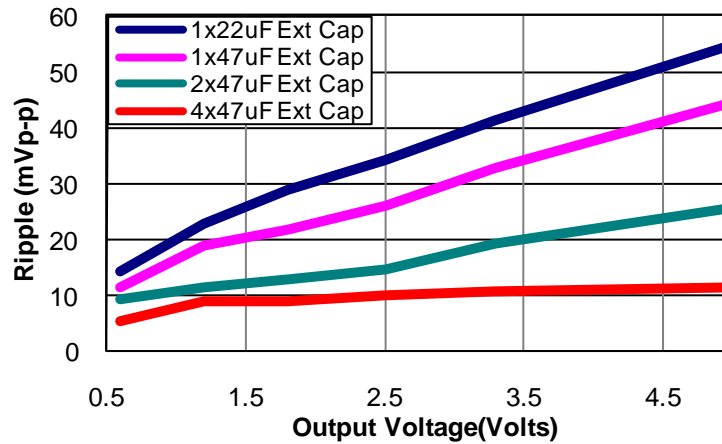


Figure 38.

NOTE: Output ripple voltage for various output voltages with external 1x22 μ F, 1x47 μ F, 2x47 μ F or 4x47 μ F ceramic capacitors at the output (12 A load). Input voltage is 12 V.

SAFETY CONSIDERATIONS

For safety agency approval the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards, i.e., UL 60950-1 2nd, CSA C22.2 No. 60950-1-07.

For the converter output to be considered meeting the requirements of safety extra-low voltage (SELV), the input must meet SELV requirements. The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

The input to these units is to be provided with a time delay fuse with a maximum rating of 15 A in the positive input lead.

MONOTONIC START-UP AND SHUTDOWN

The module has monotonic start-up and shutdown behavior for any combination of rated input voltage, output current and operating temperature range.

STARTUP INTO PRE-BIASED OUTPUT

The modules can start into a pre-biased output as long as the pre-bias voltage is 0.5 V less than the set output voltage.

OUTPUT VOLTAGE PROGRAMMING

The output voltage of the module is programmable to any voltage from 0.6Vdc to 5.5VDC by connecting a resistor between the Trim and GND pins of the module. Certain restrictions apply on the output voltage set point depending on the input voltage. These are shown in the Output Voltage vs. Input Voltage Set Point Area plot in Fig. 41. The Upper Limit curve shows that for output voltages lower than 1V, the input voltage must be lower than the maximum of 14.4 V. The Lower Limit curve shows that for output voltages higher than 0.6V, the input voltage needs to be larger than the minimum of 3 V.

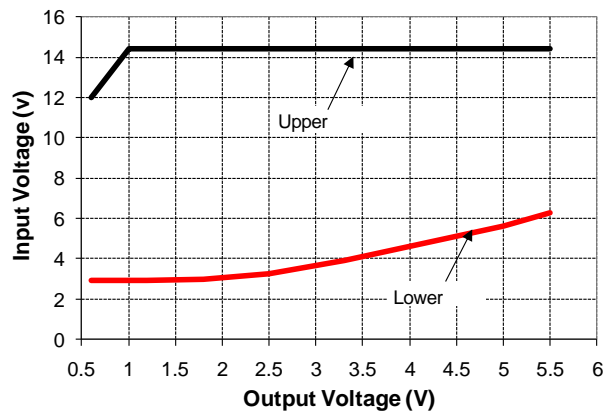


Figure 41.

Note: Output Voltage vs. Input Voltage Set Point Area plot showing limits where the output voltage can be set for different input voltages.

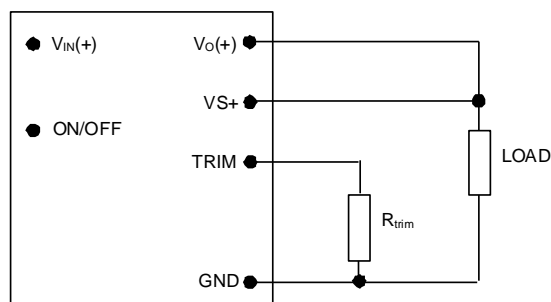


Figure 42. Circuit configuration for programming output voltage using an external resistor

Without an external resistor between Trim and GND pins, the output of the module will be 0.6VDC. To calculate the value of the trim resistor, R_{trim} for a desired output voltage, should be as per the following equation:

$$R_{trim} = \left[\frac{12}{(V_o - 0.6)} \right] k\Omega$$

R_{trim} is the external resistor in $k\Omega$

V_o is the desired output voltage. Table 1 provides R_{trim} values required for some common output voltages.

Table 1

Vo set (V)	Rtrim (K Ω)
0.6	Open
0.9	40
1.0	30
1.2	20
1.5	13.33
1.8	10
2.5	6.316
3.3	4.444
5.5	2.727

REMOTE SENSE

The power module has a Remote Sense feature to minimize the effects of distribution losses by regulating the voltage at the SENSE pin. The voltage between the SENSE pin and VOUT pin should not exceed 0.5V.

VOLTAGE MARGINING

Output voltage margining can be implemented in the module by connecting a resistor, $R_{margin-up}$, from the Trim pin to the ground pin for margining-up the output voltage and by connecting a resistor, $R_{margin-down}$, from the Trim pin to the output pin for margining-down. Figure 43 shows the circuit configuration for output voltage margining. Please consult your local Bel Power technical representative for additional details.

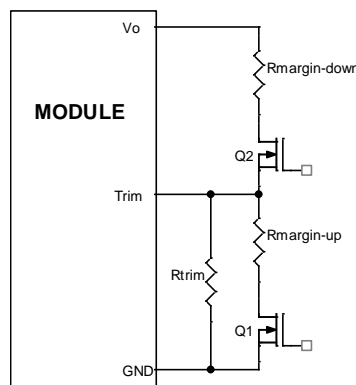


Figure 43. Circuit Configuration for margining Output voltage

OUTPUT CURRENT PROTECTION

To provide protection in a fault (output overload) condition, the unit is equipped with internal current limiting circuitry and can endure current limiting continuously. At the point of current limit inception, the unit enters hiccup mode. The unit operates normally once the output current is brought back into its specified range.

OVER TEMPERATURE PROTECTION

To provide protection in a fault condition, the unit is equipped with a thermal shutdown circuit. The unit will shutdown if the overtemperature threshold of 120 (Q1) / 130 (L1) °C (type) is exceeded at the thermal reference point Tref . Once the unit goes into thermal shutdown it will then wait to cool before attempting to restart.

INPUT UNDERVOLTAGE LOCKOUT

At input voltages below the input undervoltage lockout limit, the module operation is disabled. The module will begin to operate at an input voltage above the undervoltage lockout turn-on threshold.

POWER GOOD

The module provides a Power Good (PGOOD) signal that is implemented with an open-drain output to indicate that the output voltage is within the regulation limits of the power module. The PGOOD signal will be de-asserted to a low state if any condition such as overtemperature, overcurrent or loss of regulation occurs that would result in the output voltage going $\pm 10\%$ outside the setpoint value. The PGOOD terminal can be connected through a pullup resistor (suggested value 100K Ω) to a source of 5VDC or lower.

DUAL LAYOUT

Identical dimensions and pin layout of Analog and Digital modules permit migration from one to the other without needing to change the layout. To support this, 2 separate Trim Resistor locations have to be provided in the layout. For the digital modules, the resistor is connected between the TRIM pad and SGND and in the case of the analog module it is connected between TRIM and GND.

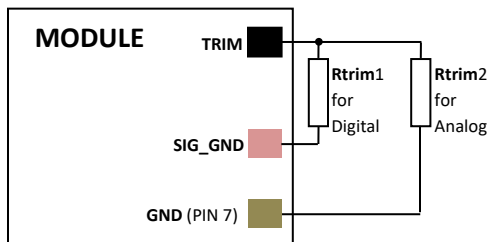


Figure 44.

Caution – Do not connect SIG_GND to GND elsewhere in the layout. Layout to support either Analog or Digital on the same pad.

TUNABLE LOOP™

The SLAN-12D2Ax modules have a feature that optimizes transient response of the module called Tunable Loop™.

External capacitors are usually added to the output of the module for two reasons: to reduce output ripple and noise (see Figure 38) and to reduce output voltage deviations from the steady-state value in the presence of dynamic load current changes. Adding external capacitance however affects the voltage control loop of the module, typically causing the loop to slow down with sluggish response. Larger values of external capacitance could also cause the module to become unstable.

The Tunable Loop™ allows the user to externally adjust the voltage control loop to match the filter network connected to the output of the module. The Tunable Loop™ is implemented by connecting a series R-C between the SENSE and TRIM pins of the module, as shown in Fig. 45. This R-C allows the user to externally adjust the voltage loop feedback compensation of the module.

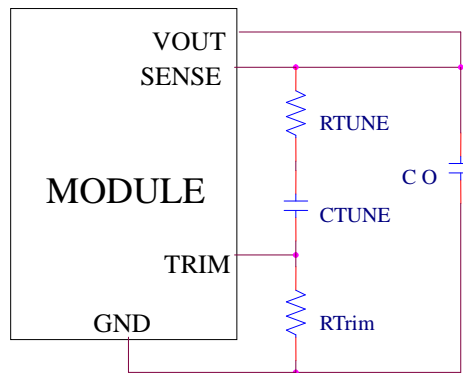


Figure 45. Circuit diagram showing connection of R_{TUNE} and C_{TUNE} to tune the control loop of the module

Recommended values of R_{TUNE} and C_{TUNE} for different output capacitor combinations are given in Tables 2 and 3. Table 2 shows the recommended values of R_{TUNE} and C_{TUNE} for different values of ceramic output capacitors up to 1000 μ F that might be needed for an application to meet output ripple and noise requirements. Selecting R_{TUNE} and C_{TUNE} according to Table 2 will ensure stable operation of the module.

In applications with tight output voltage limits in the presence of dynamic current loading, additional output capacitance will be required. Table 3 lists recommended values of R_{TUNE} and C_{TUNE} in order to meet 2% output voltage deviation limits for some common output voltages in the presence of a 6A to 12A step change (50% of full load), with an input voltage of 12V.

Please contact your Bel Power technical representative to obtain more details of this feature as well as for guidelines on how to select the right value of external R-C to tune the module for best transient performance and stable operation for other output capacitance values or input voltages other than 12V.

Table 2

Co	1x47 μ F	2x47 μ F	4x47 μ F	6x47 μ F	10x47 μ F	20x47 μ F
R_{TUNE}	330 Ω	330 Ω	330 Ω	330 Ω	270 Ω	180 Ω
C_{TUNE}	100pF	560pF	1500pF	2200pF	3900pF	6800pF

General recommended values of R_{TUNE} and C_{TUNE} for $V_{in} = 12$ V and various external ceramic capacitor combinations.

Table 3

Vo	5V	3.3V	2.5V	1.8V	1.2V	0.6V
Co	5x47 μ F	1x47 μ F + 330 μ F Polymer	3x 47 μ F + 330 μ F Polymer	1x 47 μ F + 2x 330 μ F Polymer	1x 47 μ F + 3x 330 μ F Polymer	3x 47 μ F + 6x 330 μ F Polymer
R _{TUNE}	330 Ω	330 Ω	270 Ω	270 Ω	220 Ω	180 Ω
C _{TUNE}	1500 pF	2700 pF	3300 pF	5600 pF	10 nF	47 nF
Δ V	99 mV	58 mV	47 mV	34 mV	24 mV	12 mV

Recommended values of R_{TUNE} and C_{TUNE} to obtain transient deviation of 2% of V_{out} for a 6 A step load with V_{in} = 12 V.

13. THERMAL CONSIDERATION

Power modules operate in a variety of thermal environments; however, sufficient cooling should always be provided to help ensure reliable operation.

Considerations include ambient temperature, airflow, module power dissipation, and the need for increased reliability. A reduction in the operating temperature of the module will result in an increase in reliability. The thermal data presented here is based on physical measurements taken in a wind tunnel. The test set-up is shown in Figure 46. The preferred airflow direction for the module is in Figure 47.

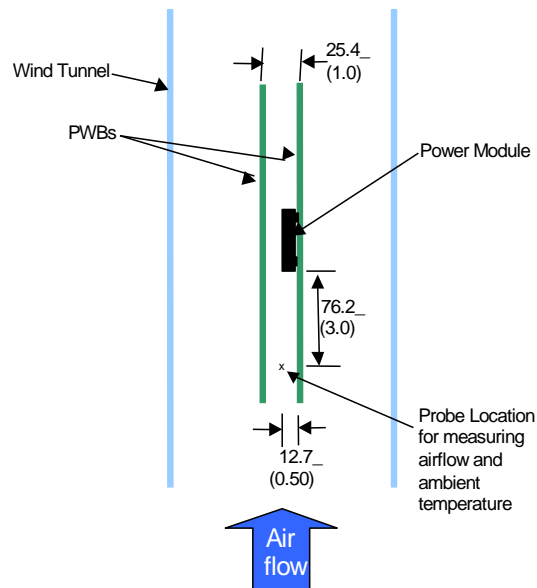


Figure 46. Thermal Test Setup

The thermal reference points, T_{ref} used in the specifications are also shown in Figure 47. For reliable operation the temperature at Q1 should not exceed 120°C and the temperature at L1 should not exceed 130°C. The output power of the module should not exceed the rated power of the module (V_{o,set} x I_{o,max}).

Please refer to the Application Note “Thermal Characterization Process for Open-Frame Board-Mounted Power Modules” for a detailed discussion of thermal aspects including maximum device temperatures.

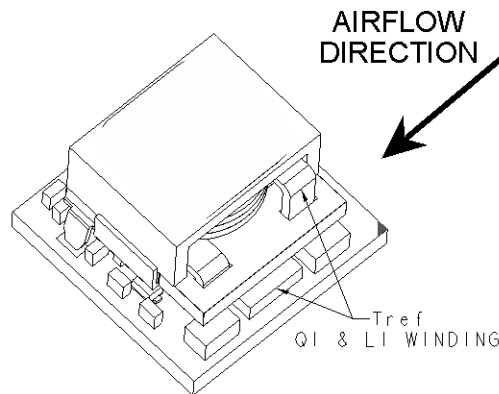


Figure 47. Preferred airflow direction and location of hot-spot of the module (T_{ref})

14. EXAMPLE APPLICATION CIRCUIT

Requirements:

Vin: 12 V
 Vout: 1.8 V
 Iout: 9 A max., worst case load transient is from 6 to 9 A
 ΔV_{out} : 1.5% of Vout (27mV) for worst case load transient
 Vin, ripple: 1.5% of Vin (180mV, p-p)

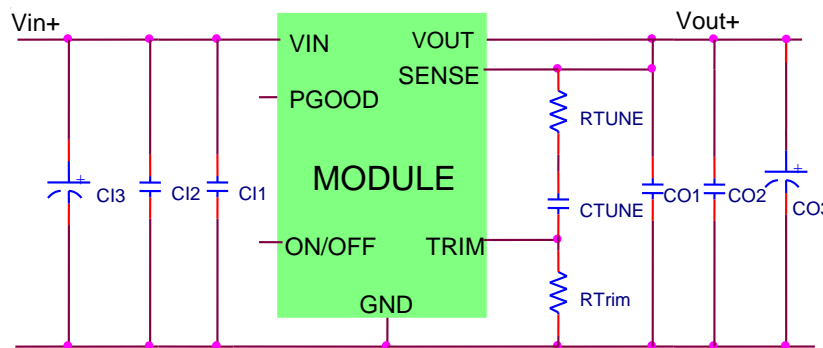


Figure 48.

C11	Decoupling cap - 1x0.01 μ F/16V ceramic capacitor (e.g. Murata LLL185R71E103MA01)
C12	2x22 μ F/16V ceramic capacitor (e.g. Murata GRM32ER61C226KE20)
C13	47 μ F/16V bulk electrolytic
CO1	Decoupling cap - 1x0.01 μ F/16V ceramic capacitor (e.g. Murata LLL185R71E103MA01)
CO2	2 x 47 μ F/6.3V ceramic capacitor (e.g. Murata GRM31CR60J476ME19)
CO3	1 x 330 μ F/6.3V Polymer (e.g. Sanyo Poscap)
CTune	3300pF ceramic capacitor (can be 1206, 0805 or 0603 size)
RTune	270 ohms SMT resistor (can be 1206, 0805 or 0603 size)
RTrim	10k Ω SMT resistor (can be 1206, 0805 or 0603 size, recommended tolerance of 0.1%)

15. MECHANICAL DIMENSIONS

OUTLINE

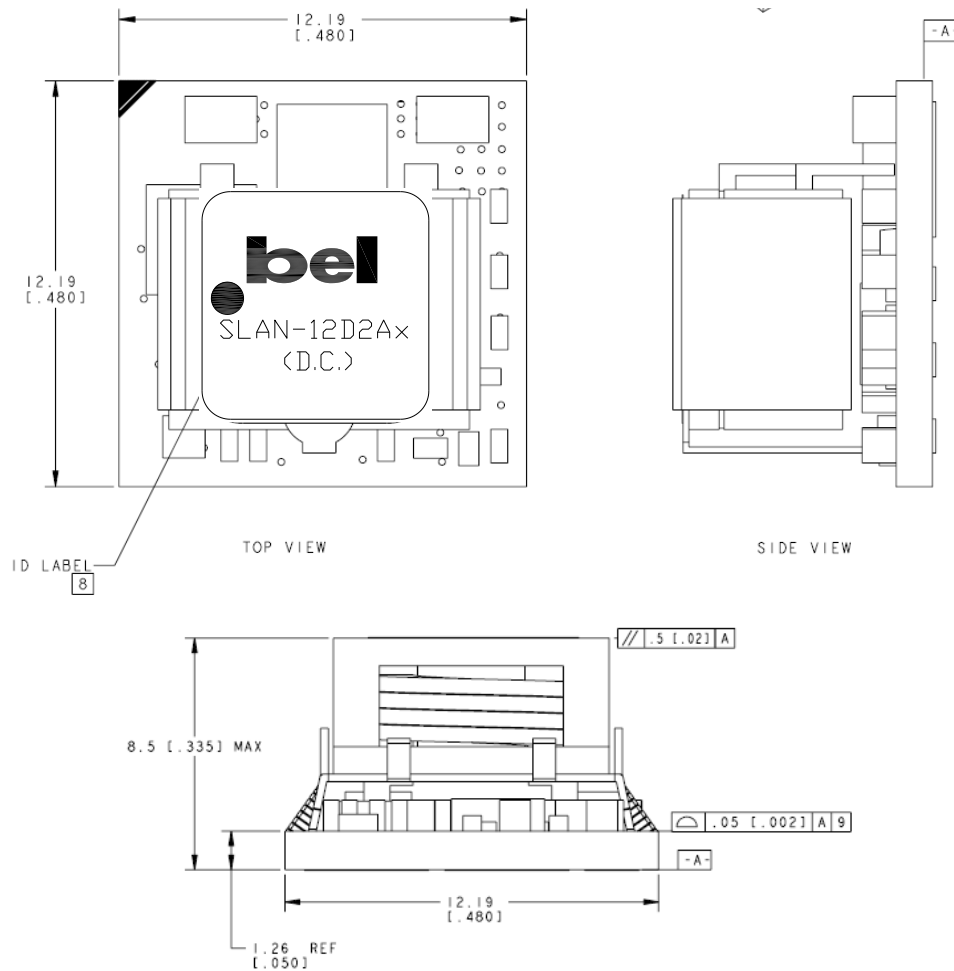


Figure 49.

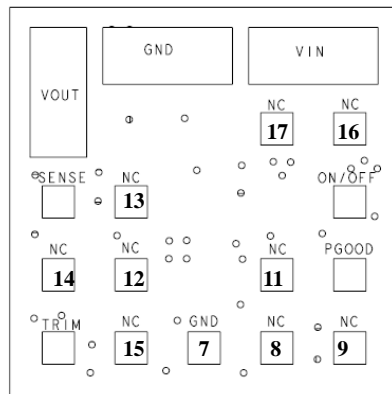
Notes:

Dimensions are in mm [inch].

Tolerances: x.x mm ± 0.5 mm [± 0.02 inch] [unless otherwise indicated]

x.xx mm ± 0.25 mm [± 0.010 inch]

PIN DEFINITIONS



BOTTOM VIEW

Figure 50. Pins

PIN	FUNCTION	PIN	FUNCTION
1	ON/OFF	10	PGOOD
2	VIN	11	NC
3	GND	12	NC
4	VOUT	13	NC
5	VS+ (SENSE)	14	NC
6	TRIM	15	NC
7	GND	16	NC
8	NC	17	NC
9	NC		

RECOMMENDED PAD LAYOUT

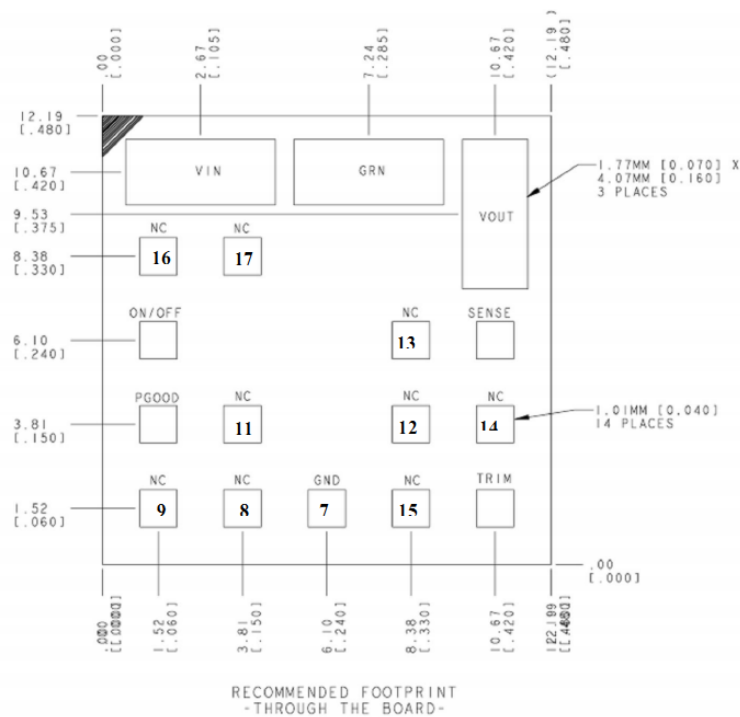
RECOMMENDED FOOTPRINT
- THROUGH THE BOARD -

Figure 51. Recommended pad layout

PIN	FUNCTION	PIN	FUNCTION
1	ON/OFF	10	PGOOD
2	VIN	11	NC
3	GND	12	NC
4	VOUT	13	NC
5	VS+ (SENSE)	14	NC
6	TRIM	15	NC
7	GND	16	NC
8	NC	17	NC
9	NC		

Dimensions are in mm [inch].

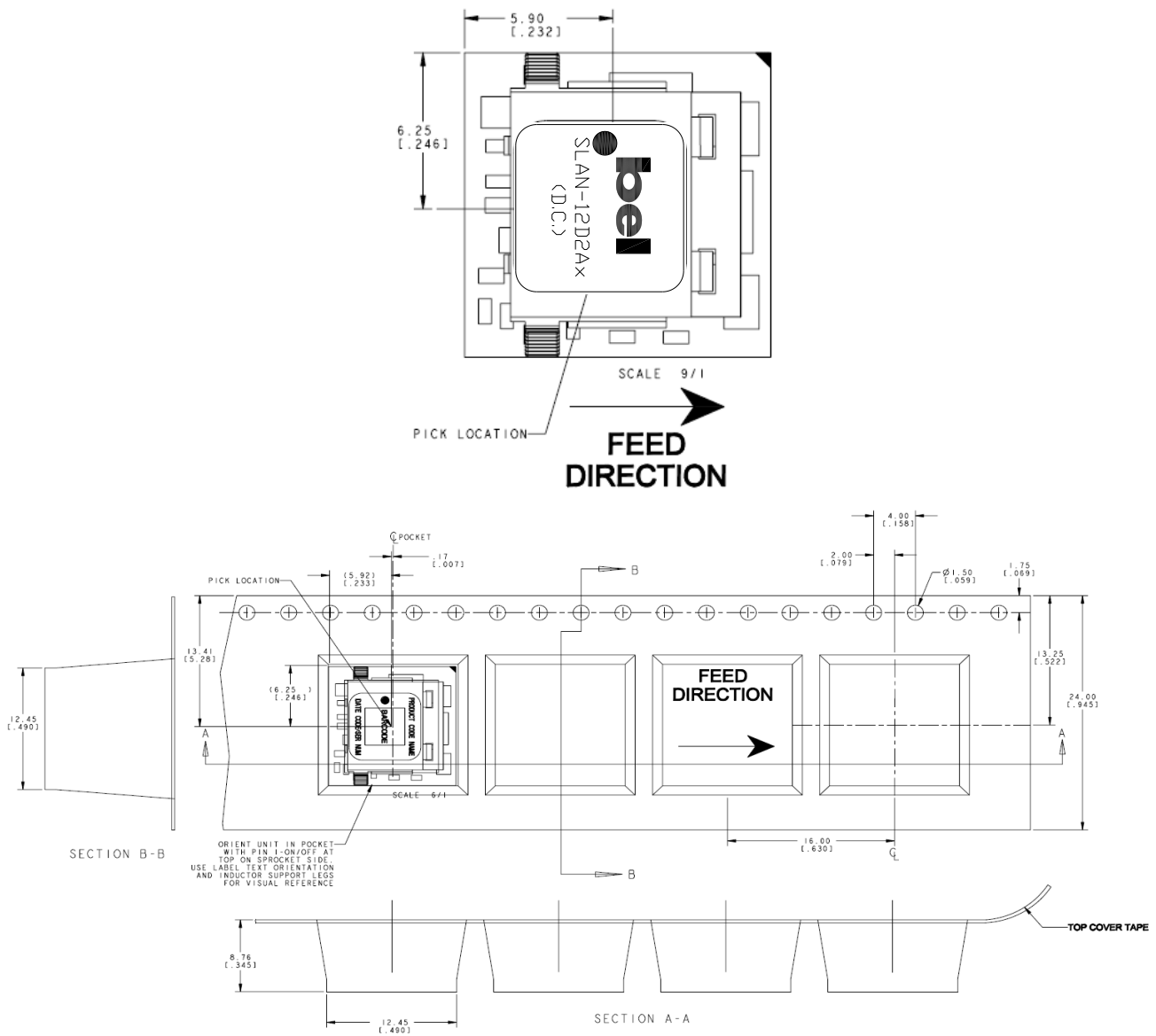
Tolerances: x.x mm \pm 0.5 mm [\pm 0.02 inch] [unless otherwise indicated]

x.xx mm \pm 0.25 mm [\pm 0.010 inch]

16. PACKAGING DETAILS

The SLAN-12D2Ax modules are supplied in tape & reel as standard.

All Dimensions are in mm [inch].



Reel Dimensions:

Outside Dimensions: 330.2 mm (13.00")

Inside Dimensions: 177.8 mm (7.00")

Tape Width: 24.00 mm (0.945")

17. SURFACE MOUNT INFORMATION

PICK AND PLACE

The SLAN-12D2Ax modules use an open frame construction and are designed for a fully automated assembly process. The modules are fitted with a label designed to provide a large surface area for pick and place operations. The label meets all the requirements for surface mount processing, as well as safety standards, and is able to withstand reflow temperatures of up to 300°C. The label also carries product information such as product code, serial number and the location of manufacture.

NOZZLE RECOMMENDATIONS

The module weight has been kept to a minimum by using open frame construction. Variables such as nozzle size, tip style, vacuum pressure and placement speed should be considered to optimize this process. The minimum recommended inside nozzle diameter for reliable operation is 3mm. The maximum nozzle outer diameter, which will safely fit within the allowable component spacing, is 7 mm.

BOTTOM SIDE / FIRST SIDE ASSEMBLY

This module is not recommended for assembly on the bottom side of a customer board. If such an assembly is attempted, components may fall off the module during the second reflow process.

LEAD FREE SOLDERING

The SLAN-12D2Ax modules are lead-free (Pb-free) and RoHS compliant and fully compatible in a Pb-free soldering process. Failure to observe the instructions below may result in the failure of or cause damage to the modules and can adversely affect long-term reliability.

PB-FREE REFLOW PROFILE

Power Systems will comply with J-STD-020 Rev. C (Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices) for both Pb-free solder profiles and MSL classification procedures. This standard provides a recommended forced-air-convection reflow profile based on the volume and thickness of the package (table 4-2). The suggested Pb-free solder paste is Sn/Ag/Cu (SAC). For questions regarding LGA, solder volume; please contact Bel power for special manufacturing process instructions.

The recommended linear reflow profile using Sn/Ag/Cu solder is shown in Fig. 48. Soldering outside of the recommended profile requires testing to verify results and performance.

MSL RATING

The SLAN-12D2Ax modules have a MSL rating of 2A.

STORAGE AND HANDLING

The recommended storage environment and handling procedures for moisture-sensitive surface mount packages is detailed in J-STD-033 Rev. A (Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices). Moisture barrier bags (MBB) with desiccant are required for MSL ratings of 2 or greater. These sealed packages should not be broken until time of use. Once the original package is broken, the floor life of the product at conditions of $\leq 30^{\circ}\text{C}$ and 60% relative humidity varies according to the MSL rating (see J-STD-033A). The shelf life for dry packed SMT packages will be a minimum of 12 months from the bag seal date, when stored at the following conditions: $< 40^{\circ}\text{C}$, $< 90\%$ relative humidity.

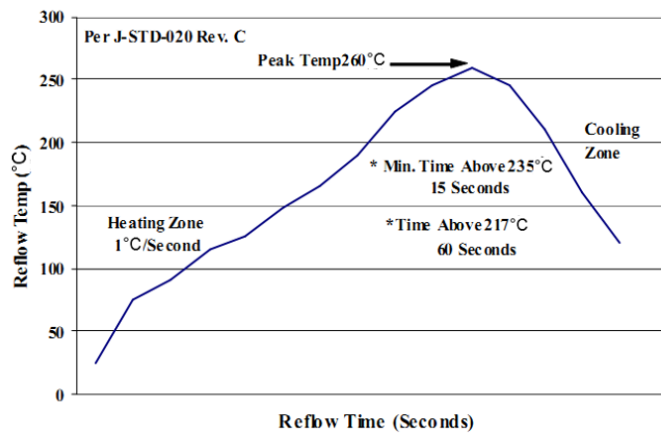


Figure 53. Recommended linear reflow profile using Sn/Ag/Cu solder

POST SOLDER CLEANING AND DRYING CONSIDERATIONS

Post solder cleaning is usually the final circuit board assembly process prior to electrical board testing. The result of inadequate cleaning and drying can affect both the reliability of a power module and the testability of the finished circuit board assembly. For guidance on appropriate soldering, cleaning and drying procedures, refer to Board Mounted Power Modules: Soldering and Cleaning Application Note (AN04-001).

18. REVISION HISTORY

DATE	REVISION	CHANGES DETAIL	APPROVAL
2012-03-20	A	First release.	HL.LU
2015-07-13	B	Update part selection, absolute maximum ratings, output specifications, general specifications, remote on/off, voltage margining, dual layout, Pb-free reflow profile, MSL rating and packaging details.	XF.Jiang
2021-06-04	AC	Add object ID and module photo. Update to new form. Delete safety considerations about VDE information.	XF.Jiang

For more information on these products consult: tech.support@psbel.com

NUCLEAR AND MEDICAL APPLICATIONS - Products are not designed or intended for use as critical components in life support systems, equipment used in hazardous environments, or nuclear control systems.

TECHNICAL REVISIONS - The appearance of products, including safety agency certifications pictured on labels, may change depending on the date manufactured. Specifications are subject to change without notice.



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